

NT116WHM-N44
Product Specification
Rev. 01

BOE Optoelectronics Technology Co., Ltd

REVISION HISTORY

() Preliminary Specification

(√) Final Specification

Revision No.	Page	Description of Changes	Date	Prepared
0	34	Final Specification	2018.11.12	Chen Xin
01	34	Revise : Change 2 lane to 1 lane In feature 1.2 of page 4	2019.3.18	Chen Xin

REVIEWED**Designer****Manager**

Liu Zhulin(Array)

Wang Xiaolin

Lei Dan(Cell)

Hu Jingyong

Zhang Shouqiang(CF)

Wang Xiaolin

Ran Bo(EE)

Gao Xianyong

Yu Pingjia(MO)

Gao Liang

Huang LongBo(QE)

Huang Yuan

Wen Jianghong(PI)

Wang Zhihui

APPROVED

Chen Xin(PM)

Contents

No.	Items	Page
1.0	General Description	4
2.0	Absolute Maximum Ratings	6
3.0	Electrical Specifications	7
4.0	Optical Specifications	10
5.0	Interface Connection	15
6.0	Signal Timing Specification	19
7.0	Input Signals, Display Colors & Gray Scale of Colors	21
8.0	Power Sequence	22
9.0	Connector Description	23
10.0	Mechanical Characteristics	24
11.0	Reliability Test	25
12.0	Handling & Cautions	25
13.0	Label	26
14.0	Packing Information	28
15.0	Mechanical Outline Dimension	29
16.0	EDID Table	31

1.0 GENERAL DESCRIPTION

1.1 Introduction

NT116WHM-N44 is a color active matrix TFT LCD module using amorphous silicon TFT's (Thin Film Transistors) as an active switching devices. This module has a 11.6 inch diagonally measured active area with HD resolutions (1366 horizontal by 768 vertical pixel array). Each pixel is divided into RED, GREEN, BLUE dots which are arranged in vertical stripe and this module can display 262k(6bit) colors and color gamut 45%. The TFT-LCD panel used for this module is a low reflection and higher color type. Therefore, this module is suitable for Notebook PC. The LED driver for back-light driving is built in this model.

All input signals are eDP1.2 interface compatible.

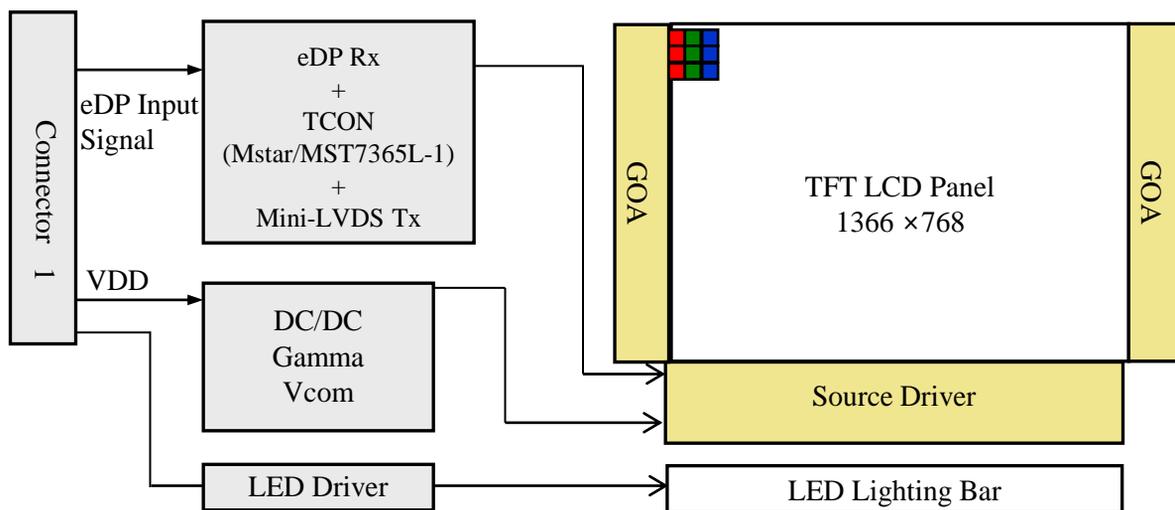


Figure 1. Drive Architecture

1.2 Features

- 1 lane eDP interface with 2.7Gbps link rates
- Thin and light weight
- 262k(6bit) color depth, color gamut 45%
- Single LED lighting bar (Bottom side/Horizontal Direction)
- Data enable signal mode
- Side mounting frame
- Green product (RoHS & Halogen free product)
- On board LED driving circuit
- Low driving voltage and low power consumption
- On board EDID chip

1.3 Application

- Notebook PC (Wide type)

1.4 General Specification

The followings are general specifications at the model NT116WHM-N44. (listed in Table 1)

<Table 1. General Specifications>

Parameter	Specification	Unit	Remarks
Active area	256.125(H) × 144.00(V)	mm	
Number of pixels	1366 (H) × 768 (V)	pixels	
Pixel pitch	0.1875 (H) X 0.1875 (V)	mm	
Pixel arrangement	RGB Vertical stripe		
Display colors	262k(6bit)		
Color gamut	45%		
Display mode	Normally white		
Dimensional outline	268 ± 0.3(H)*168.04 ± 0.5(V) (W/PCB)*3.0(Max) 268 ± 0.3(H) *172.98 ± 0.5(V) (W/BRACKET)*3.0(Max)	mm	
Weight	210(max)	g	
Surface treatment	Anti-Glare		
Surface hardness	3H		
Back-light	Bottom edge side, 1-LED lighting bar type		Note 1
Power consumption	P _D : 0.7	W	@Mosaic
	P _{BL} : 1.65	W	
	P _{Total} : 2.35	W	@Mosaic

Notes : 1. LED Lighting Bar (24*LED Array)

SPEC. NUMBER

SPEC. TITLE

NT116WHM-N44 Product Specification Rev. 01

PAGE

5 OF 34

2.0 ABSOLUTE MAXIMUM RATINGS

The followings are maximum values which, if exceed, may cause faulty operation or damage to the unit. The operational and non-operational maximum voltage and current values are listed in Table 2.

< Table 2. Absolute Maximum Ratings >

Ta=25+/-
2° C

Parameter	Symbol	Min.	Max.	Unit	Remarks
Power Supply Voltage	V _{DD}	-0.3	4.0	V	Note 1
Logic Supply Voltage	V _{IN}	V _{SS} -0.3	V _{DD} +0.3	V	
Operating Temperature	T _{OP}	0	+50	° C	Note 2
Storage Temperature	T _{ST}	-20	+60	° C	

Notes :

1. Permanent damage to the device may occur if maximum values are exceeded functional operation should be restricted to the condition described under normal operating conditions.

2. Temperature and relative humidity range are shown in the figure below.

95 % RH Max. (40 ° C ≥ Ta) Maximum wet - bulb temperature at 39 ° C or less. (Ta > 40 ° C) No condensation.

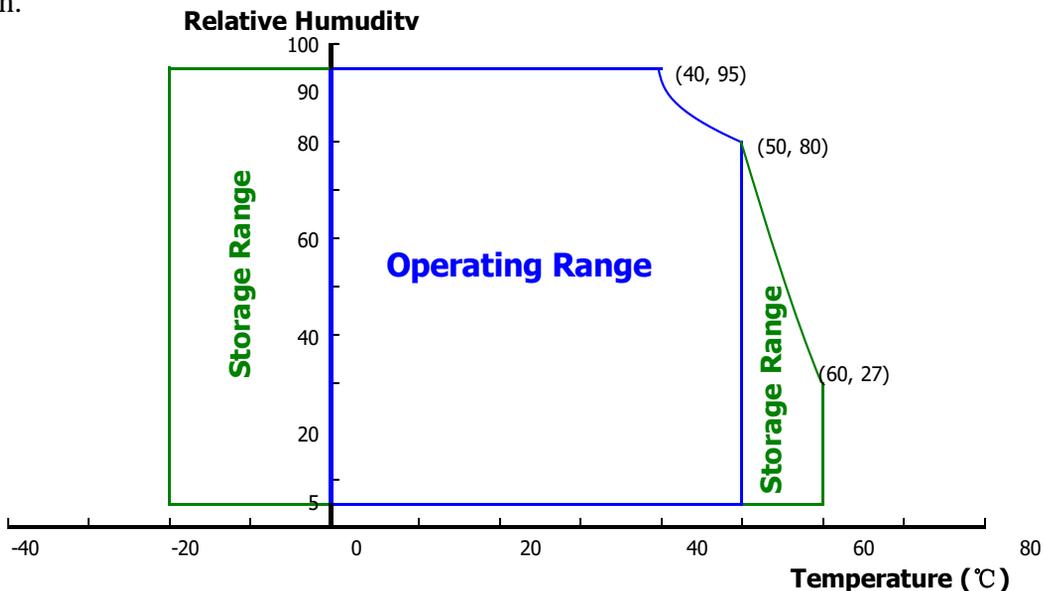


Figure 2. Temperature and Relative Humidity Range

3.0 ELECTRICAL SPECIFICATIONS

3.1 Electrical Specifications

< Table 3. Electrical Specifications >

Ta=25+/-2°C

Parameter		Min.	Typ.	Max.	Unit	Remarks
Power Supply Voltage	V _{DD}	3.0	3.3	3.6	V	Note 1
Permissible Input Ripple Voltage	V _{RF}	-	-	100	mV	@ V _{DD} = 3.3V
BIST Control Level	High Level	2	-	3.6	V	-
	Low Level	0	-	0.8	V	-
Power Supply Current	I _{DD}	-	212	303	mA	Note 1
Power Supply Inrush Current	I _{inrush}	-	-	2	A	Note3
Power Consumption	P _D	-	0.7	1.0	W	Note 1
	P _{BL}	-	-	1.65	W	Note 2
	P _{total}	-	-	2.65	W	Note 1

Notes :

1. The supply voltage is measured and specified at the interface connector of LCM.

The current draw and power consumption specified is for 3.3V at 25 °C.

a) Typ : Mosaic pattern 8*8

b) Max : R/G/B patterns

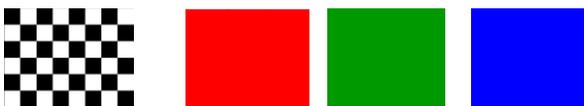


Figure 3. Power Measure Patterns

(a)

(b)

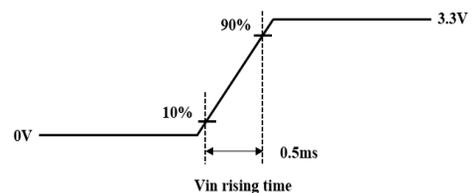


Figure 4. Inrush Measure Condition

2. Calculated value for reference (V_{LED} × I_{LED})

3. Measure condition (Figure 4)

3.2 Backlight Unit

< Table 4. LED Driving Guideline Specifications >

Ta=25+/-2°C

Parameter		Min.	Typ.	Max.	Unit	Remarks
LED Forward Voltage	V _F	-	-	2.9	V	-
LED Forward Current	I _F	-	20	-	mA	-
LED Power Consumption	P _{LED}	-	-	1.65	W	Note 1
LED Life-Time	N/A	15,000	-	-	Hour	I _F = 20mA
Power Supply Voltage for LED Driver	V _{LED}	5	12	21	V	-
Power Supply Voltage for LED Driver Inrush	I _{led inrush}	-	-	2	A	Note 4
EN Control Level	Backlight On	2.5	-	5.0	V	-
	Backlight Off	0	-	0.6	V	-
PWM Control Level	High Level	2.5	-	5.0	V	-
	Low Level	0	-	0.6	V	-
PWM Control Frequency	F _{PWM}	200	-	10,000	Hz	-
Duty Ratio		1	-	100	%	Note 3

Notes :

1. Power supply voltage 12V for LED driver.

Calculator value for reference $I_F \times V_F \times 24 / \text{driver efficiency} = P_{LED}$

2. The LED life-time define as the estimated time to 50% degradation of initial luminous.

3. 1% duty cycle is achievable with a dimming frequency less than 1KHz.

4. Measure condition (Figure 5)

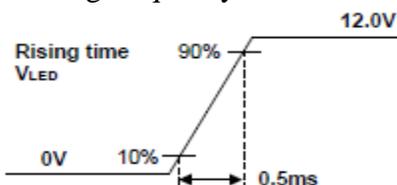


Figure 5. Inrush Measure Condition

3.3 LED Structure

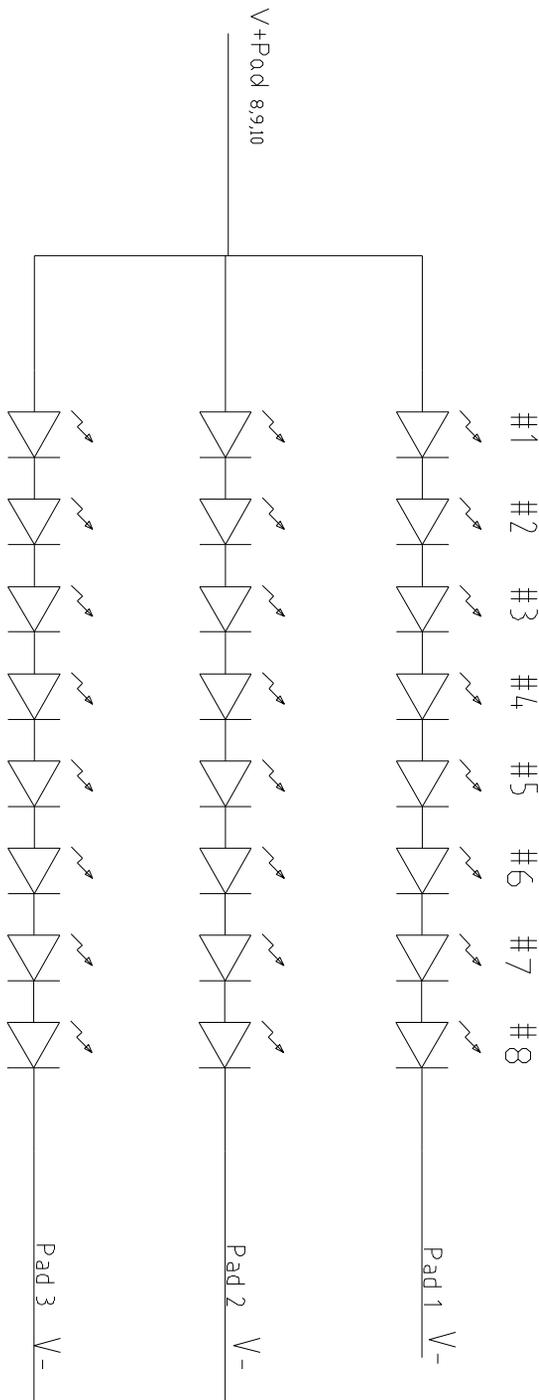


Figure 6. LED Structure

4.0 OPTICAL SPECIFICATION

4.1 Overview

The test of optical specifications shall be measured in a dark room (ambient luminance ≤ 1 lux and temperature = $25 \pm 2^\circ\text{C}$) with the equipment of luminance meter system (PR730&PR810) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0° . We refer to $\theta=0$ ($=\theta_3$) as the 3 o'clock direction (the "right"), $\theta=90$ ($=\theta_{12}$) as the 12 o'clock direction ("upward"), $\theta=180$ ($=\theta_9$) as the 9 o'clock direction ("left") and $\theta=270$ ($=\theta_6$) as the 6 o'clock direction ("bottom"). While scanning θ and/or Φ , the center of the measuring spot on the display surface shall stay fixed. The backlight should be operating for 30 minutes prior to measurement. VDD shall be $3.3 \pm 0.3\text{V}$ at 25°C . Optimum viewing angle direction is 6 o'clock.

4.2 Optical Specifications

<Table 5. Optical Specifications>

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Viewing Angle Range	Horizontal	θ_3	CR > 10	40	45	-	Deg.	Note 1
		θ_9		40	45	-	Deg.	
	Vertical	θ_{12}		15	20	-	Deg.	
		θ_6		30	40	-	Deg.	
Luminance Contrast Ratio		CR	$\theta = 0^\circ$	400	500	-		Note 2
Luminance of White	5 Points	Y_w	$\theta = 0^\circ$ ILED = 21mA	187	220	-	cd/m ²	Note 3
White Luminance Uniformity	5 Points	ΔY_5		80	-	-	%	Note 4
	13 Points	ΔY_{13}		65	-	-	%	
White Chromaticity		W_x	$\theta = 0^\circ$	0.283	0.313	0.343	-	Note 5
		W_y		0.299	0.329	0.359	-	
Reproduction of Color	Red	R_x	$\theta = 0^\circ$	-0.03	0.580	+0.03	-	-
		R_y			0.357		-	-
	Green	G_x			0.343		-	-
		G_y			0.580		-	-
	Blue	B_x			0.162		-	-
		B_y			0.11		-	-
Color Gamut		-	-	-	45	-	%	-
Response Time (Rising + Falling)		T_{RT}	$T_a = 25^\circ\text{C}$ $\theta = 0^\circ$	-	12	16	ms	Note 6
Cross Talk		CT	$\theta = 0^\circ$	-	-	2	%	Note 7

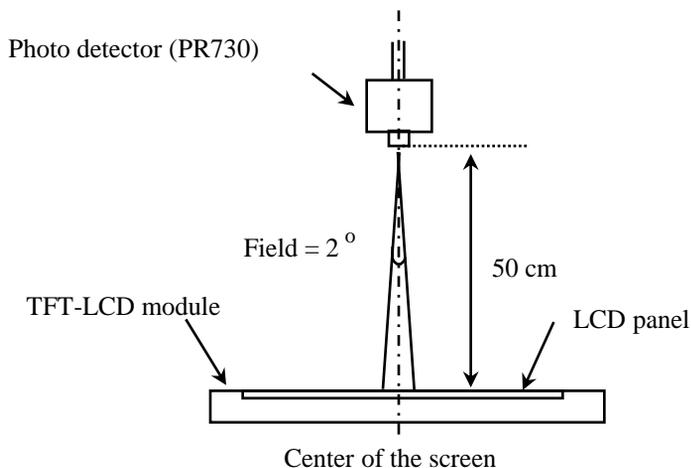
Notes :

1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see Figure 7).
2. Contrast measurements shall be made at viewing angle of $\Theta = 0$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state . (see Figure 7) Luminance Contrast Ratio (CR) is defined mathematically.

$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

3. Center Luminance of white is defined as luminance values of 5 point average across the LCD surface. Luminance shall be measured with all pixels in the view field set first to white. This measurement shall be taken at the locations shown in Figure 8 for a total of the measurements per display.
4. The White luminance uniformity on LCD surface is then expressed as : $\Delta Y = \text{Minimum Luminance of 5(or 13) points} / \text{Maximum Luminance of 5(or 13) points.}$ (see Figure 8 and Figure 9).
5. The color chromaticity coordinates specified in Table 5 shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.
6. The electro-optical response time measurements shall be made as Figure 10 by switching the “data” input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is T_r , and 90% to 10% is T_r .
7. Cross-Talk of one area of the LCD surface by another shall be measured by comparing the luminance (YA) of a 10 ± 1 mm diameter area, with all display pixels set to gray 127(of 0 to 255), to the luminance (YB) of that same area when any adjacent area is driven dark. The luminance ratio shall not exceed 1:1.05 (See Figure 11).

4.3 Optical Measurements



Optical characteristics measurement setup

Figure 7. Measurement Set Up

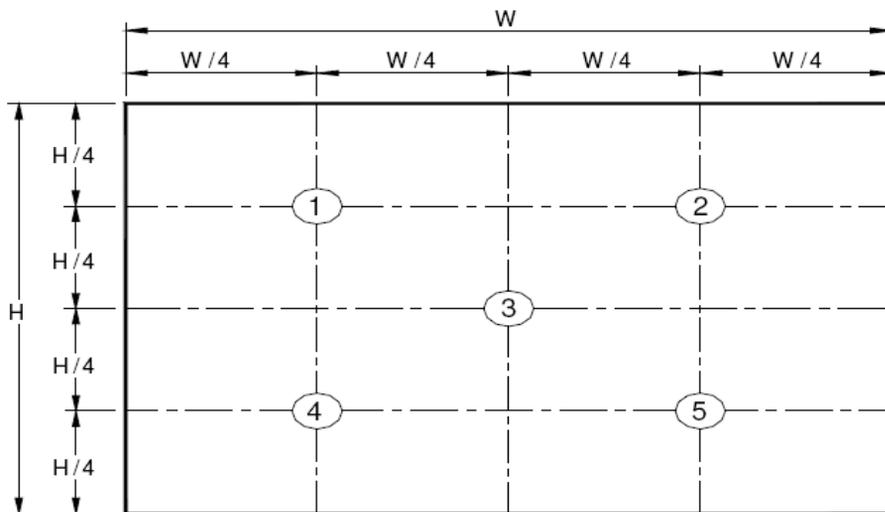


Figure 8. White Luminance and Uniformity Measurement Locations (5 points)

Center Luminance of white is defined as luminance values of center 5 points across the LCD surface. Luminance shall be measured with all pixels in the view field set first to white. This measurement shall be taken at the locations shown in Figure 7 for a total of the measurements per display.

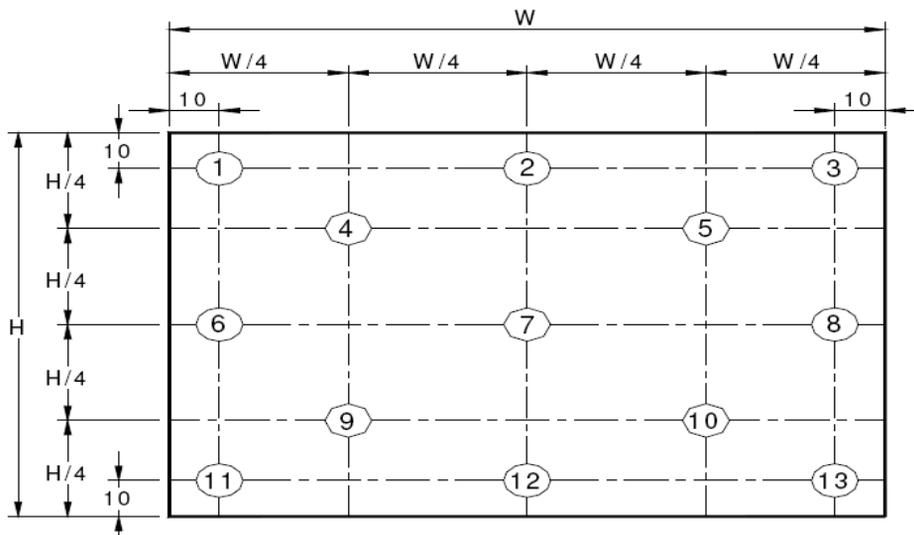


Figure 9. Uniformity Measurement Locations (13 points)

The White luminance uniformity on LCD surface is then expressed as : $\Delta Y5 = \text{Minimum Luminance of five points} / \text{Maximum Luminance of five points}$ (see Figure 8) , $\Delta Y13 = \text{Minimum Luminance of 13 points} / \text{Maximum Luminance of 13 points}$ (see Figure 9).

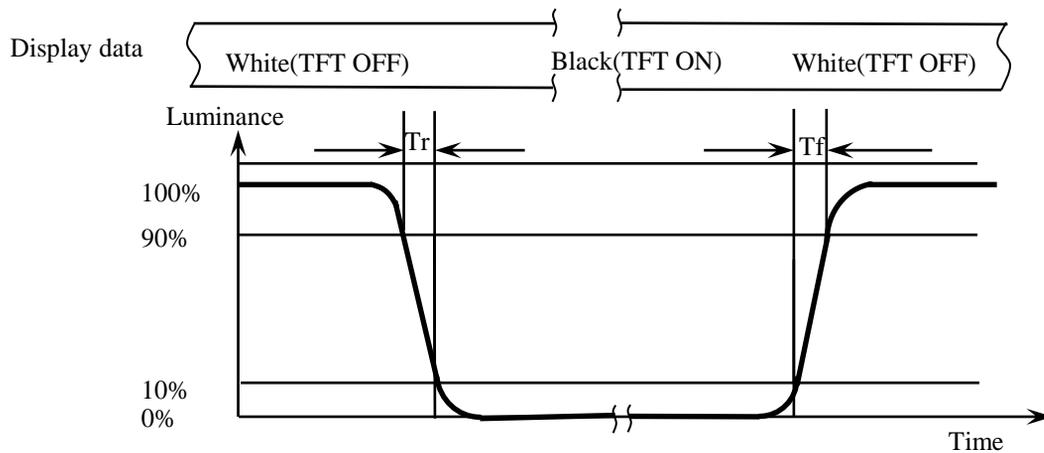
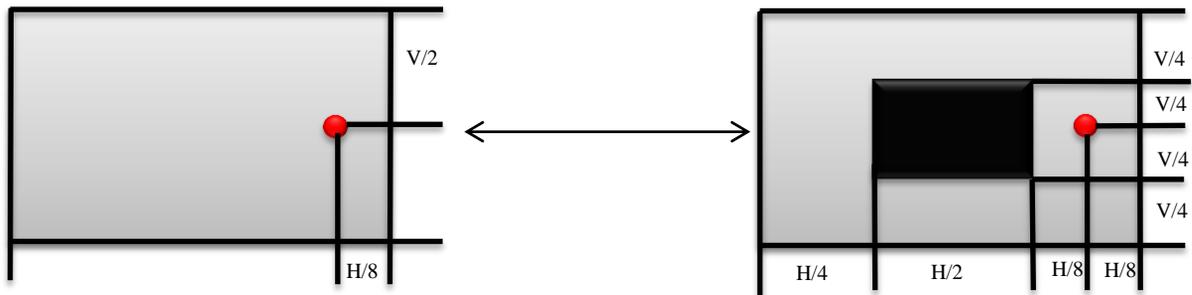


Figure 10. Response Time Testing

The electro-optical response time measurements shall be made as shown in Figure 10 by switching the “data” input signal ON and OFF. Tr: The luminance to change from 90% to 10% ,Tf: The luminance to change from 10% to 90% .

The test system : PR810



$$\text{Cross Talk (\%)} = \left| \frac{Y_B - Y_A}{Y_B} \right| \times 100$$

Figure 11. Cross Talk Modulation Test Description

Where:

Y_A = Initial luminance of measured area (cd/m²)

Y_B = Subsequent luminance of measured area (cd/m²)

The location measured will be exactly the same in both patterns. The test background gray is L127.

Cross Talk of one area of the LCD surface by another shall be measured by comparing the luminance (Y_A) of a 10 ± 1 mm diameter area, with all display pixels set to a gray level 127, to the luminance (Y_B) of that same area when any adjacent area is driven dark.(Refer to Figure 11)

The test system: PR730

5.0 INTERFACE CONNECTION

5.1 Electrical Interface Connection

The electronics interface connector is I-PEX 20455-030E-66.

The connector interface pin assignments are listed in Table 6.

<Table 6. Pin Assignments for the Interface Connector>

Terminal	Symbol	Functions
Pin No.	Symbol	Description
1	NC	No Connection
2	H_GND	Ground
3	LANE1_N	No Connection
4	LANE1_P	No Connection
5	H_GND	Ground
6	LANE0_N	eDP RX Channel 0 Negative
7	LANE0_P	eDP RX Channel 0 Positive
8	H_GND	Ground
9	AUX_CH_P	eDP AUX CH Positive
10	AUX_CH_N	eDP AUX CH Negative
11	H_GND	Ground
12	LCD_VCC	Power Supply, 3.3V (typ.)
13	LCD_VCC	Power Supply, 3.3V (typ.)
14	NC	No Connection
15	H_GND	Ground
16	H_GND	Ground
17	HPD	Hot Plug Detect Output
18	BL_GND	LED Ground
19	BL_GND	LED Ground
20	BL_GND	LED Ground
21	BL_GND	LED Ground
22	BL_ENABLE	LED Enable Pin(+3.3V Input)
23	BL_PWM	System PWM Signal Input
24	NC	No Connection
25	NC	No Connection
26	BL_POWER	LED Power Supply 5V-21V
27	BL_POWER	LED Power Supply 5V-21V
28	BL_POWER	LED Power Supply 5V-21V
29	BL_POWER	LED Power Supply 5V-21V
30	NC	No Connection

5.2 eDP Interface

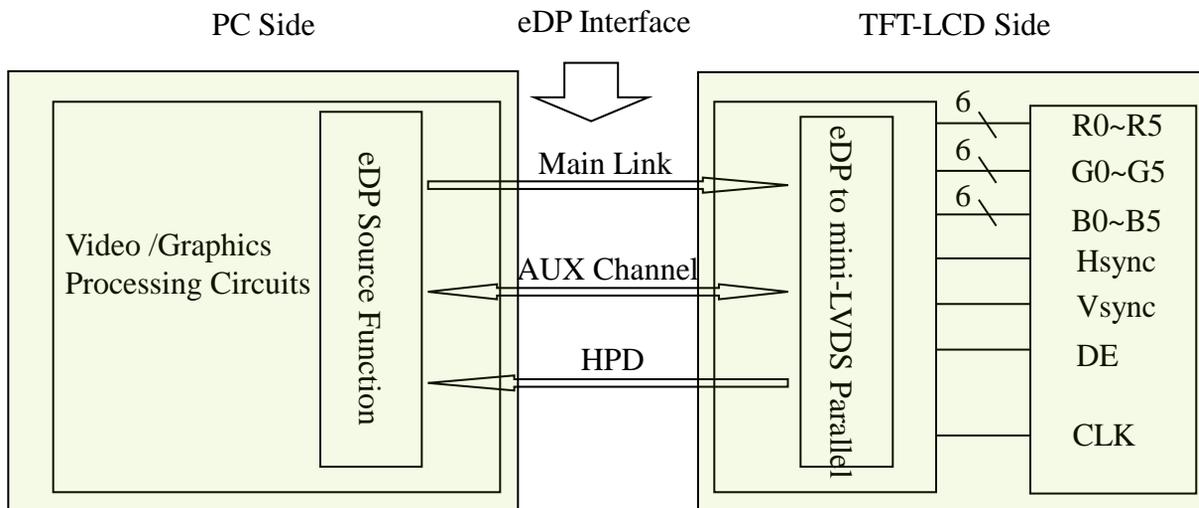


Figure 12. eDP Interface Architecture

Note:

Transmitter : Parade DP501 or equivalent.

Transmitter is not contained in module.

5.3 Data Input Format

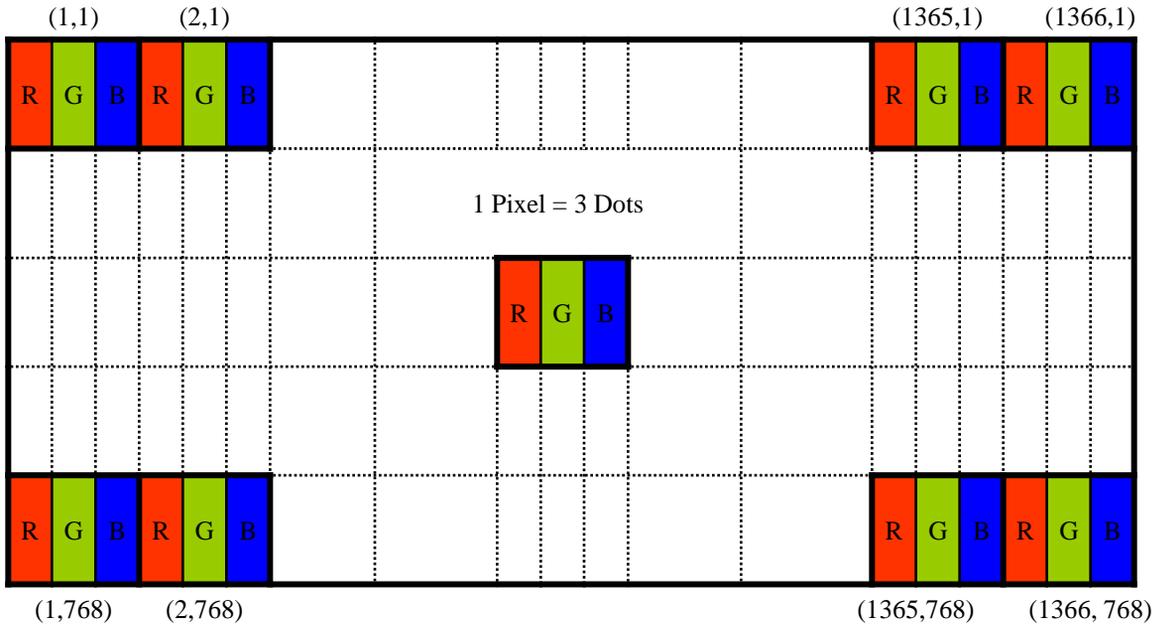


Figure 13. Display Position of Input Data (V-H)

5.4 Back-light & LCM Interface Connection

BLU Interface Connector: STM MSK24022P10.

<Table 7. Pin Assignments for the BLU Connector>

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	LED1	LED cathode connection	6	GND	Ground
2	LED2	LED cathode connection	7	NC	No Connection
3	LED3	LED cathode connection	8	Vout	LED anode connection
4	NC	No Connection	9	Vout	LED anode connection
5	NC	No Connection	10	Vout	LED anode connection

6.0 SIGNAL TIMING SPECIFICATION**6.1 The NT116WHM-N44 Is Operated By The DE Only**

< Table 8. Signal Timing Specification >

Item		Symbols	Min	Typ	Max	Unit
Clock	Frequency	1/Tc	73.8	74.5	75.2	MHz
Frame Period		Tv	798	803	808	lines
			-	60	-	Hz
			-	16.67	-	ms
Vertical Display Period		Tvd	-	768	-	lines
One line Scanning Period		Th	1541	1546	1551	clocks
Horizontal Display Period		Thd	-	1366	-	clocks

Note : The above is as optimized setting.

6.2 eDP Rx Interface Timing Parameter

The specification of the eDP Rx interface timing parameter is shown in Table 9.

<Table 9. eDP Main-Link RX TP4 Package Pin Parameters>

Item	Symbol	Min	Typ	Max	Unit	Remark
Spread spectrum clock (Link clock down-spreading)	ssc	-0.5	-	0	%	
Differential peak-to-peak input voltage at package pins	VRX-DIFFp-p	100	-	1320	mV	
Rx input DC common mode voltage	VRX_DC_CM	0	-	2	V	
Differential termination resistance	RRX-DIFF	80	-	120	Ω	
Single-ended termination resistance	RRX-SE	40	-	60	Ω	
Rx short circuit current limit	IRX_SHORT	-	-	50	mA	
Intra-pair skew at Rx package pins (HBR) RX intra-pair skew tolerance at HBR	LRX_SKEW_INTRA_PAIR	-	-	60	ps	

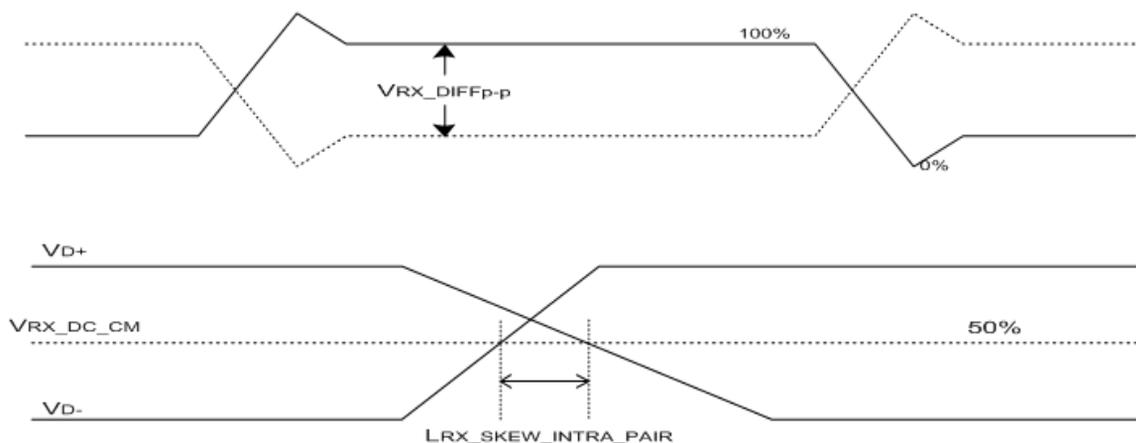


Figure 14. $VRX-DIFFp-p$ & $LRX_SKEW_INTRA_PAIR$

7.0 INPUT SIGNALS, BASIC DISPLAY COLORS & GRAY SCALE OF COLORS

<Table 10. Input Signal & Basic Display Colors & Gray Scale of Colors >

	Colors & Gray scale	Data signal																	
		R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	B0	B1	B2	B3	B4	B5
Basic colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Light Blue	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Purple	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray scale of Red	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	△	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Darker	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	△																		
	▽																		
	Brighter	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Gray scale of Green	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	△	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
	Darker	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
	△																		
	▽																		
	Brighter	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
Gray scale of Blue	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	△	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
	Darker	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
	△																		
	▽																		
	Brighter	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
Gray scale of White & Black	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	△	1	0	0	0	0	0	1	0	0	0	0	0	1	0	0	0	0	0
	Darker	0	1	0	0	0	0	0	1	0	0	0	0	0	1	0	0	0	0
	△																		
	▽																		
	Brighter	1	0	1	1	1	1	1	0	1	1	1	1	1	0	1	1	1	1
White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	

8.0 POWER SEQUENCE

To prevent a latch-up or DC operation of the LCD module, the power on/off sequence shall be as shown in below.

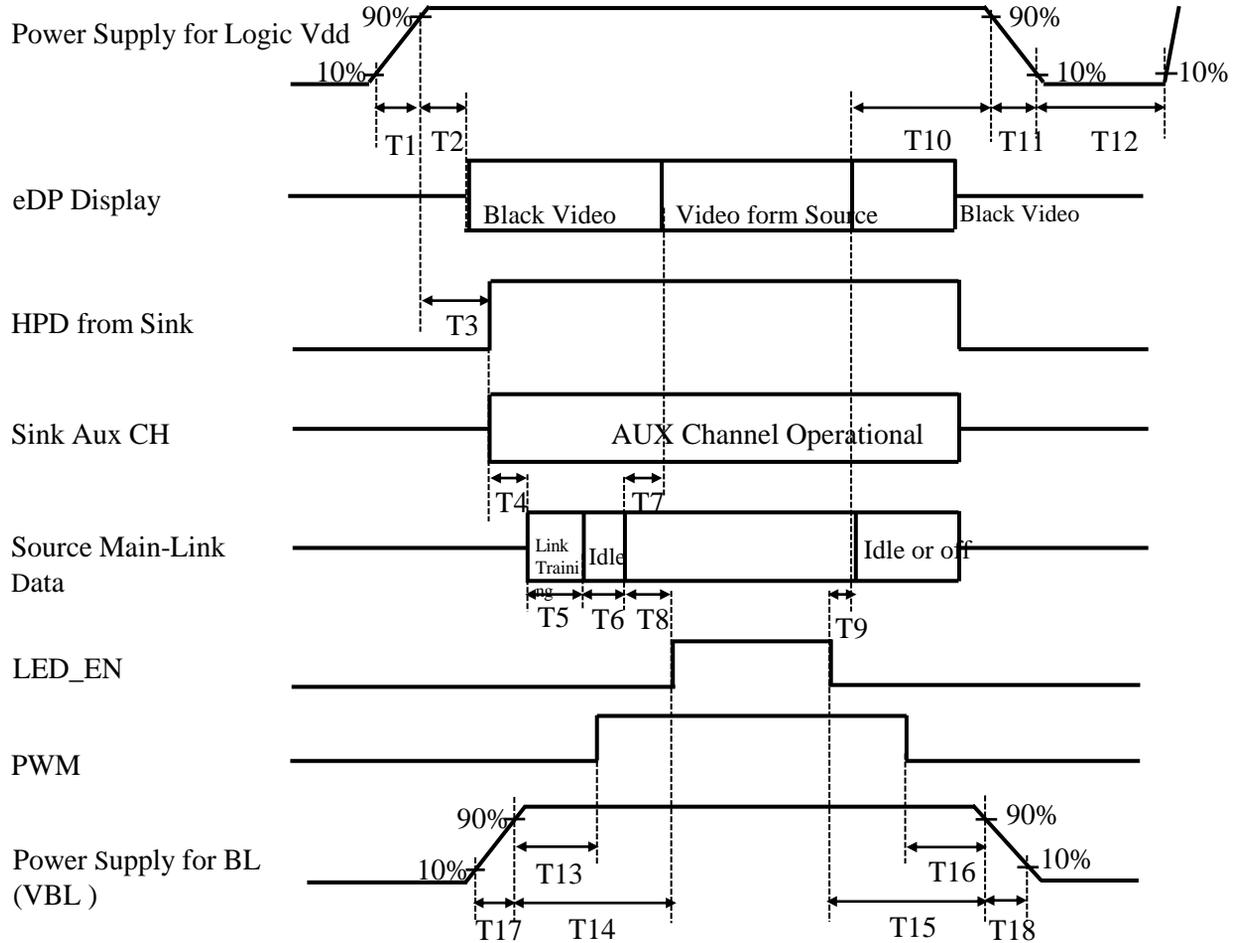


Figure 15. Power Sequence

- $0.5\text{ms} \leq T1 \leq 10\text{ms}$
- $0\text{ms} < T2 \leq 200\text{ms}$
- $0\text{ms} < T3 \leq 200\text{ms}$
- $T3+T4+T5+T6+T8 > 200\text{ms}$
- $0\text{ms} < T7 \leq 50\text{ms}$
- $50\text{ms} < T8$
- $0\text{ms} < T9$
- $0\text{ms} < T10 < 500\text{ms}$
- $0.5\text{ms} \leq T11 \leq 10\text{ms}$
- $500\text{ms} \leq T12$
- $0\text{ms} < T13$
- $0\text{ms} < T14$
- $0\text{ms} < T15$
- $0\text{ms} < T16$
- $0.5\text{ms} \leq T17$
- $0.5\text{ms} \leq T18$

Notes:

- When the power supply VDD is 0V, keep the level of input signals on the low or keep high impedance.
- Do not keep the interface signal high impedance when power is on. Back Light must be turn on after power for logic and interface signal are valid.

9.0 Connector Description

Physical interface is described as for the connector on LCM.

These connectors are capable of accommodating the following signals and will be following components.

9.1 TFT LCD Module

< Table 11. Signal Connector >

Connector Name /Description	For Signal Connector
Manufacturer	I-PEX
Type/ Part Number	I-PEX 20455-030E-66
Mating Housing/ Part Number	I-PEX 20454-030T

10.0 MECHANICAL CHARACTERISTICS

10.1 Dimensional Requirements

Figure 23 shows mechanical outlines for the model NT116WHM-N44.
Other parameters are shown in Table 12.

<Table 12. Dimensional Parameters>

Parameter	Specification	Unit
Active Area	256.125(H) × 144.00(V)	mm
Number of pixels	1366 (H) X 768 (V) (1 pixel = R + G + B dots)	pixels
Pixel pitch	187.5 (H) X 187.5 (V)	um
Pixel arrangement	RGB Vertical stripe	
Display colors	262K(6bit)	
Display mode	Normally white	
Dimensional outline	268 ± 0.3(H) * 168.04 ± 0.5(V) (W/PCB) * 3.0(Max) 268 ± 0.3(H) * 172.98 ± 0.5(V) (W/BRACKET) * 3.0(Max)	mm
Weight	210 (max)	g

10.2 Mounting

See Figure 20.

10.3 Anti-Glare and Polarizer Hardness.

The surface of the LCD has an AG coating to maximize readability and hard coating to reduce scratching.

10.4 Light Leakage

There shall not be visible light from the back-lighting system around the edges of the screen as seen from a distance 50cm from the screen with an overhead light level of 350lux.

11.0 RELIABILITY TEST

The reliability test items and its conditions are shown in below.

<Table 13. Reliability Test>

No	Test Items	Conditions
1	High temperature storage test	Ta = 60° C , 60%RH, 240 hrs
2	Low temperature storage test	Ta = -20° C , 240 hrs
3	High temperature & high humidity operation test	Ta = 50° C , 80%RH, 240 hrs
4	High temperature operation test	Ta = 50° C , 60%RH, 240 hrs
5	Low temperature operation test	Ta = 0° C , 240 hrs
6	Thermal shock	Ta = -20° C ↔ 60° C (0.5 hr), 60% ±3%RH, 100 cycle
7	Vibration test (non-operating)	Ta = 25° C , 60%RH, 1.5G, 10~500Hz, Sine X,Y,Z / Sweep rate : 1 hour
8	Shock test (non-operating)	Ta = 25° C , 60%RH, 220G, Half Sine Wave 2msec±X,±Y,±Z Once for each direction
9	Electro-static discharge test (operating)	Air : 150 pF, 330Ω, 15 KV Contact : 150 pF, 330Ω, 8 KV Ta = 25° C , 60%RH,

12.0 HANDLING & CAUTIONS

(1) Cautions when taking out the module

- Pick the pouch only, when taking out module from a shipping package.

(2) Cautions for handling the module

- As the electrostatic discharges may break the LCD module, handle the LCD module with care. Peel a protection sheet off from the LCD panel surface as slowly as possible.
- As the LCD panel and back - light element are made from fragile glass material, impulse and pressure to the LCD module should be avoided.
- As the surface of the polarizer is very soft and easily scratched, use a soft dry cloth without chemicals for cleaning.
- Do not pull the interface connector in or out while the LCD module is operating.
- Put the module display side down on a flat horizontal plane.
- Handle connectors and cables with care.

(3) Cautions for the operation

- When the module is operating, do not lose CLK, ENAB signals. If any one of these signals is lost, the LCD panel would be damaged.
- Obey the supply voltage sequence. If wrong sequence is applied, the module would be damaged.

(4) Cautions for the atmosphere

- Dew drop atmosphere should be avoided.
- Do not store and/or operate the LCD module in a high temperature and/or humidity atmosphere. Storage in an electro-conductive polymer packing pouch and under relatively low temperature atmosphere is recommended.

(5) Cautions for the module characteristics

- Do not apply fixed pattern data signal to the LCD module at product aging.
- Applying fixed pattern for a long time may cause image sticking.

(6) Other cautions

- Do not disassemble and/or re-assemble LCD module.
- Do not re-adjust variable resistor or switch etc.
- When returning the module for repair or etc. Please pack the module not to be broken. We recommend to use the original shipping packages.

13.0 LABEL

(1) Product Label



Figure 16. Product Label

Module ID Naming Rule:

<Table 14. Module ID Naming Rule>

Digit	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17
Code	S	L	S	5	1	2	3	5	9	4	2	0	0	0	1	D	B
Description	Model Code /GBN		Grade	Line	Year		Month	Model Extension Code (Last 4 Digits Of FGCOD)				Serial No 00001-ZZZZZZ					

(2) High voltage caution label

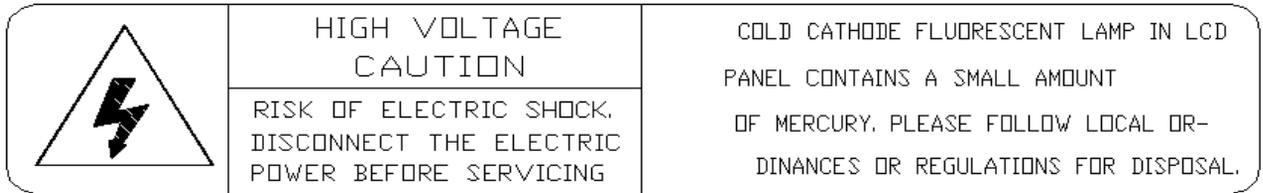


Figure 17. High Voltage Caution Label

(3) Box Label

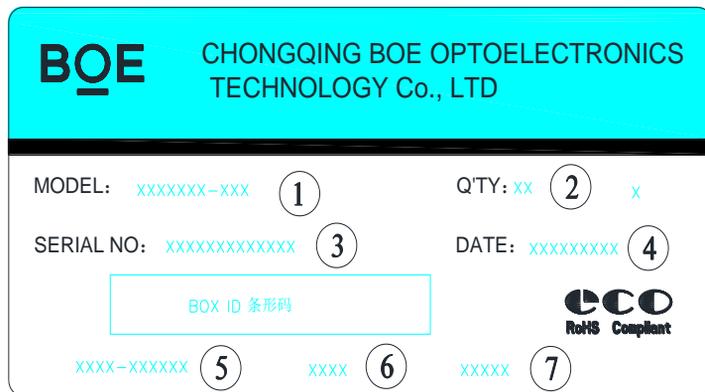


Figure 18. Box Label

Serial number marked part needs to print, show as follows:

1. FG-CODE(Before 12 bit)
2. Product quantity
3. Box ID
4. Date
5. The client section material number(The client)---XXXXXX-XXX
6. FG-Code After four ---8D30
7. The supplier code
8. Total Size:100×50mm

<Table 15. Box Label Naming Rule >

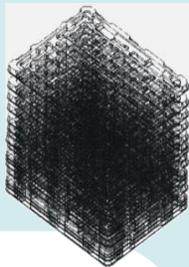
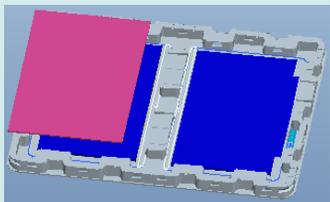
Digit	1	2	3	4	5	6	7	8	9	10	11	12	13
Code	S	L	S	F	1	2	3	D	0	0	0	6	8
Description	Products GBN		Grade	Line	Year		Month	Revision Code	Serial No				

14.0 PACKING INFORMATION

14.1 Packing Order

Place 21 layers of Tray filled with LCM & Spacer in sequence with 1EA empty Tray placed on it, and place the stacking 21EA Tray in the PE Bag - Capacity: 40pcs LCM / 21 Tray, 40pcs Spacer / 21 Tray

step
1

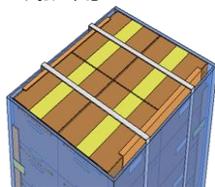


step
2

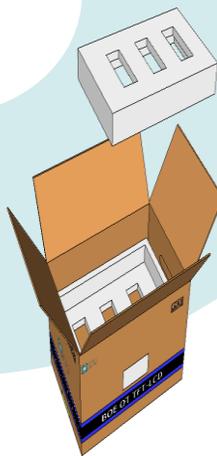


纸护角 打包带

step
4



step
3



- Each Pallet put three layers of Box, 1 layer 4 boxes, a total of 12ea Box
- Pallet four sides and packing tape placed after the paper angle, wrapping film
- Capacity: 480pcs / Pallet

- Put the PET Tray into the Inner Box and place the EPE Board up and down
- Artificial way
- Capacity: 40pcs / Inner Box

14.2 Packing Order

- Box Dimension: 545mm×465mm×290mm
- Package Quantity in one Box: 40pcs
- Total Weight: 16.1kg

15.0 MECHANICAL OUTLINE DIMENSION

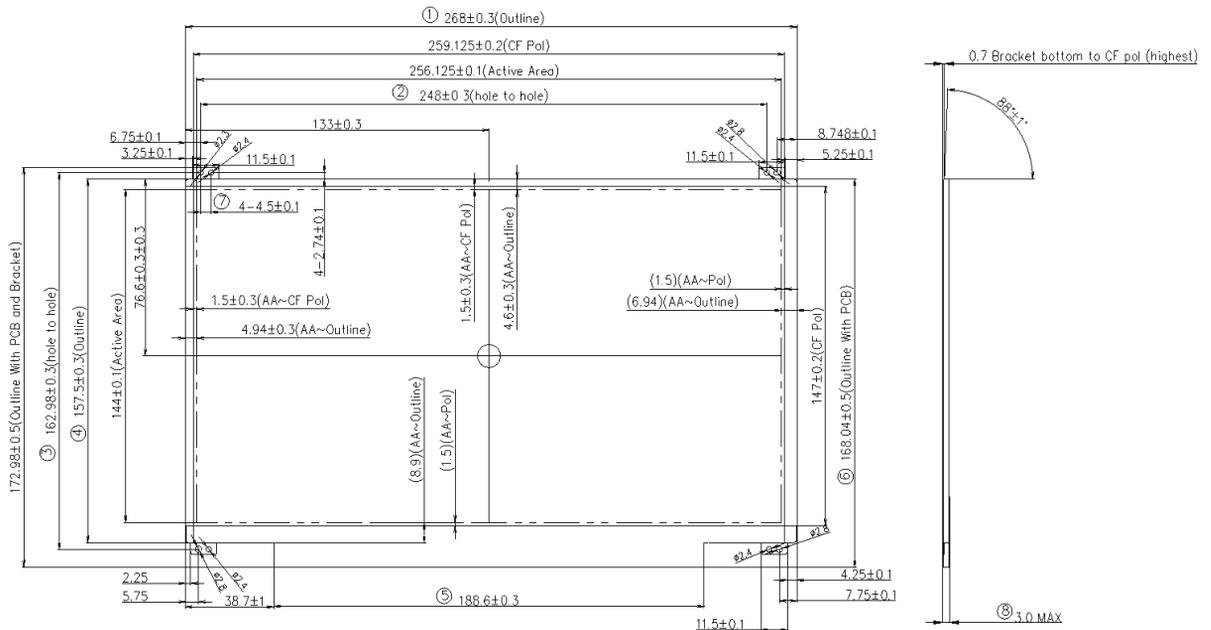


Figure 20. TFT-LCD Module Outline Dimension (Front View)

1. Note:
2. Warps And Deformation spec 0.5mm Max.
3. EDP connector is measured at PIN 1 and MATING LINE.
4. Key dimensions: ①-⑩.
5. Top Polarizer must be the highest portion.
6. The MDL dimensions measure tool is a Vernier Caliper.
7. There is no light leakage at the four corners of MDL.
8. "()" marks the reference dimensions.

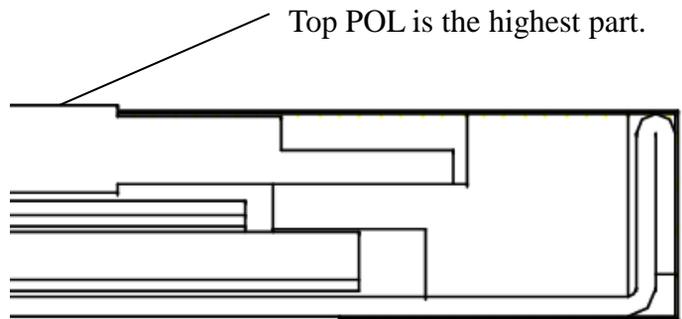


Figure 21. Highest Point Position

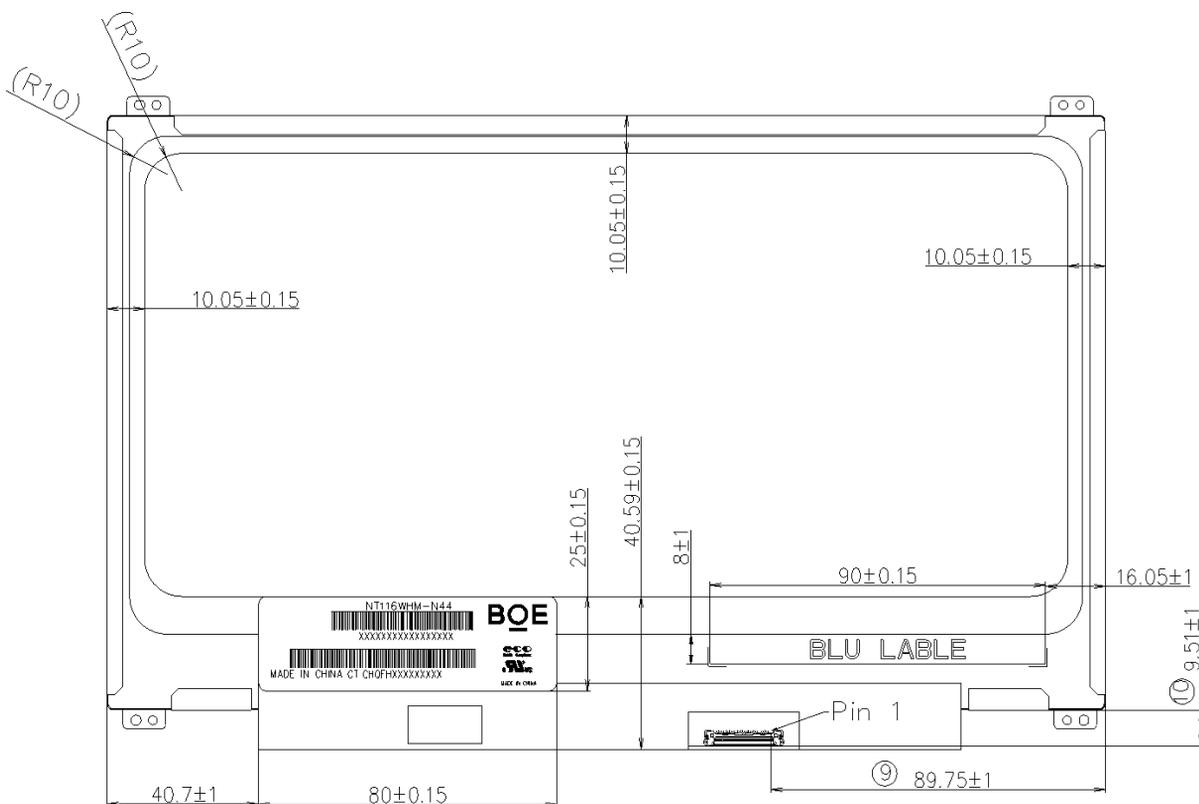


Figure 22. TFT-LCD Module Outline Dimensions (Rear view)

1. Note:
2. Warps And Deformation spec 0.5mm Max.
3. EDP connector is measured at PIN 1 and MATING LINE.
4. Key dimensions: ①-⑩.
5. Top Polarizer must be the highest portion.
6. The MDL dimensions measure tool is a Vernier Caliper.
7. There is no light leakage at the four corners of MDL.
8. "()"marks the reference dimensions.

16.0 EDID Table

Address (HEX)	Function	Hex	Dec	Input values	Notes
00	Header	00	0	0	EDID Header
01		FF	255	255	
02		FF	255	255	
03		FF	255	255	
04		FF	255	255	
05		FF	255	255	
06		FF	255	255	
07		00	0	0	
08	ID Manufacturer Name	09	9	BOE	ID = BOE
09		E5	229		
0A	ID Product Code	0C	12	2060	ID = 2060
0B		08	8		
0C	32-bit serial No.	00	0	0	
0D		00	0	0	
0E		00	0	0	
0F		00	0	0	
10	Week of manufacture	1F	31	31	
11	Year of Manufacture	1C	28	2018	Manufactured in 2018
12	EDID Structure Ver.	01	1	1	EDID Ver 1.0
13	EDID revision #	04	4	4	EDID Rev. 0.4
14	Video input definition	95	149	-	Video Signal Interface
15	Max H image size	1A	26	26	26cm (Approx)
16	Max V image size	0E	14	14	14cm (Approx)
17	Display Gamma	78	120	2.2	Gamma curve = 2.2
18	Feature support	03	3	-	Feature Support
19	Red/Green low bits	5D	93	-	Red / Green Low Bits
1A	Blue/White low bits	40	64	-	Blue / White Low Bits
1B	Red x high bits	94	148	0.580	Red (x) = 10010100 (0.580)
1C	Red y high bits	5B	91	0.357	Red (y) = 01011011 (0.357)
1D	Green x high bits	57	87	0.343	Green (x) = 01010111 (0.343)
1E	Green y high bits	94	148	0.580	Green (y) = 10010100 (0.580)
1F	Blue x high bits	29	41	0.162	Blue (x) = 00101001 (0.162)
20	Blue y high bits	1C	28	0.11	Blue (y) = 00011100 (0.11)
21	White x high bits	50	80	0.313	White (x) = 01010000 (0.313)
22	White y high bits	54	84	0.329	White (y) = 01010100 (0.329)

23	Established timing 1	00	0	-	--
24	Established timing 2	00	0	-	
25	Established timing 3	00	0	-	
26	Standard timing #1	01	1		Not Used
27		01	1		
28	Standard timing #2	01	1		Not Used
29		01	1		
2A	Standard timing #3	01	1		Not Used
2B		01	1		
2C	Standard timing #4	01	1		Not Used
2D		01	1		
2E	Standard timing #5	01	1		Not Used
2F		01	1		
30	Standard timing #6	01	1		Not Used
31		01	1		
32	Standard timing #7	01	1		Not Used
33		01	1		
34	Standard timing #8	01	1		Not Used
35		01	1		
36	Detailed timing/monitor descriptor #1	18	24		74.48MHz Main clock
37		1D	29	74.5	
38		56	86	1366	Hor Active = 1366
39		B4	180	180	Hor Blanking = 180
3A		50	80	-	4 bits of Hor. Active + 4 bits of Hor. Blanking
3B		00	0	768	Ver Active = 768
3C		23	35	35	Ver Blanking = 35
3D		30	48	-	4 bits of Ver. Active + 4 bits of Ver. Blanking
3E		30	48	48	Hor Sync Offset = 48
3F		20	32	32	H Sync Pulse Width = 32
40		36	54	3	V sync Offset = 3 line
41		00	0	6	V Sync Pulse width : 6 line
42		00	0	256	Horizontal Image Size = 256 mm (Low 8 bits)
43		90	144	144	Vertical Image Size = 144 mm (Low 8 bits)
44		10	16	-	4 bits of Hor Image Size + 4 bits of Ver Image Size
45		00	0	0	Hor Border (pixels)
46		00	0	0	Vertical Border (Lines)
47	1A	26	-	Detailed timing Definition	

48	Detailed timing/monitor descriptor #2	65	101		49.657MHz Main clock Hor Active = 1366 Hor Blanking = 180 4 bits of Hor. Active + 4 bits of Hor. Blanking Ver Active = 768 Ver Blanking = 35 4 bits of Ver. Active + 4 bits of Ver. Blanking Hor Sync Offset = 48 H Sync Pulse Width = 32 V sync Offset = 3 line V Sync Pulse width : 6 line Horizontal Image Size = 256 mm (Low 8 bits) Vertical Image Size = 144 mm (Low 8 bits) 4 bits of Hor Image Size + 4 bits of Ver Image Size Hor Border (pixels) Vertical Border (Lines) Detailed timing Definition
49		13	19	49.7	
4A		56	86	1366	
4B		B4	180	180	
4C		50	80	-	
4D		00	0	768	
4E		23	35	35	
4F		30	48	-	
50		30	48	48	
51		20	32	32	
52		36	54	3	
53		00	0	6	
54		00	0	256	
55		90	144	144	
56		10	16	-	
57		00	0	0	
58		00	0	0	
59		1A	26	-	
5A		Detailed timing/monitor descriptor #3	00	0	
5B	00		0		
5C	00		0		
5D	00		0		
5E	00		0		
5F	00		0		
60	00		0		
61	00		0		
62	00		0		
63	00		0		
64	00		0		
65	00	0			
66	00	0			
67	00	0			
68	00	0			
69	00	0			
6A	00	0			
6B	00	0			

6C	Detailed timing/monitor descriptor #4	00	0		Detailed Timing Description #4
6D		00	0		Flag
6E		00	0		Reserved
6F		02	2		For Brightness Table and Power consumption
70		00	0		Flag
71		0D	13	-	PWM % [7:0] @ Step 0 = 4.8%
72		49	73	-	PWM % [7:0] @ Step 5 = 28.9%
73		FF	255	-	PWM % [7:0] @ Step 10 = 100%
74		0A	10	-	Nits [7:0] @ Step 0 = 10Nits
75		3C	60	-	Nits [7:0] @ Step 5 = 60Nits
76		6E	110	-	Nits [7:0] @ Step 10 = 220Nits
77		11	17	-	Panel Electronics Power @32x32 Chess Pattern = 700mW
78		0B	11	-	Backlight Power @60 nits = 476.47mW
79		14	20	-	Backlight Power @Step 10 = 1650mW
7A		6E	110	-	Nits @ 100% PWM Duty = 220nit
7B		00	0	-	Format : terminate with ASCII code 0Ah and pad field with ASCII code 20h
7C		00	0	-	
7D	00	0	-		
7E	Extension flag	00	0	1	-
7F	Checksum	EC	236	-	Checksum